

# AX34063AP / AX34063AS

DC-to-DC Converter Integrate Circuit Devices

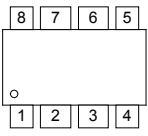
## Description

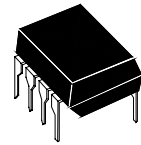
The AX34063A Series is a monolithic control circuit containing the primary functions required for DC-to-DC converters. These devices consist of an internal temperature compensated reference, comparator, controlled duty cycle oscillator with an active current limit circuit, driver and high current output switch. This series was specifically by Avantics Microelectronics Corp.

## Features

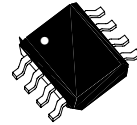
- 3V to 40V Input Voltage Operation
- Internal 1.6A Peak Current Switch
- Internal  $\pm 1.8\%$  Reference
- Low Quiescent Current at 1.6mA
- Frequency Operation from 100Hz~100KHz
- Output Voltage Adjustable
- Active Current Limiting
- Step-Up, Step-Down or Inverting Switching Regulators

## Pin Connections

	Pin1: Switch Collector (SWC)	Pin5: Comparator Inverting Input (FB)
	Pin2: Switch Emitter (SWE)	Pin6: Voltage Supply (Vcc)
	Pin3: Timing Capacitor (TC)	Pin7: Ipk Sense (Ipk)
	Pin4: Ground (GND)	Pin8: Voltage Driver Collector (DRC)



8-Lead Plastic **DIP-8**  
Package Code: P



8-Lead Plastic **SO-8**  
Package Code: S

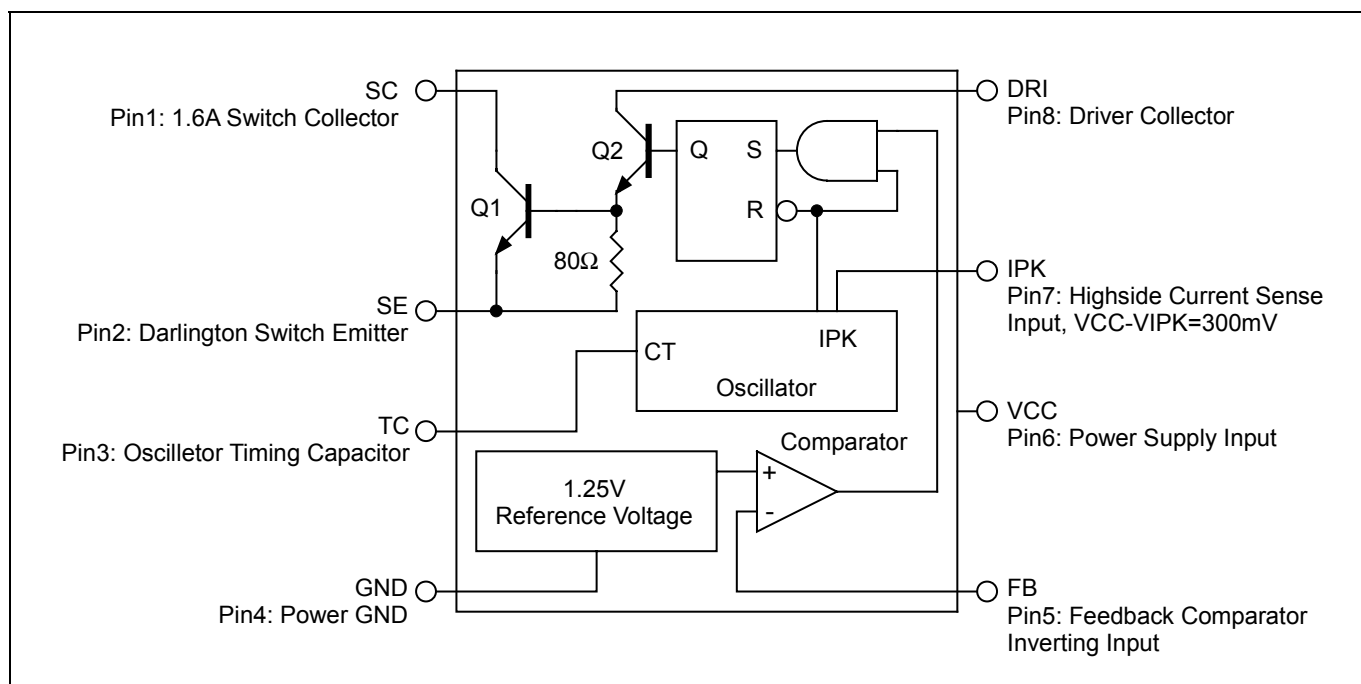
## Absolute Maxium Rating

Parameter	Symbol	Value		Unit
Power Supply Voltage	$V_{CC}$	40		V
Comparator Input Voltage Range	$V_{ir}$	-0.3~+40		V
Switch Collector Voltage	$V_{C(SW)}$	40		V
Switch Emitter Voltage	$V_{SWE}$	40		V
Switch Emitter to Collector Voltage	$V_{CE}$	40		V
Driver Collector Voltage	$V_{C(DR)}$	40		V
Switch Current	$I_{SW}$	1.5		A
Power Dissipation at $T_j=20^\circ\text{C}$	$P_D$	DIP-8	1.25	W
		SO-8	0.625	
Operating Ambient Temperature Range	$T_{opr}$	0~+70		$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-65~+150		$^\circ\text{C}$
Operating Junction Temperature	$T_{opj}$	120		$^\circ\text{C}$
Thermal Resistance Junction-ambient	$\theta_{JA}$	125		$^\circ\text{C/W}$

## Electrical Characteristics ( $V_{CC}=5V, T_A=0\sim 70^{\circ}C$ , unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<i>Oscillator</i>						
Charging Current	$I_{chg}$	$V_{CC}=5\sim 40V, T_a=25^{\circ}C$	10	25	40	$\mu A$
Discharge Current	$I_{dischg}$	$V_{CC}=5\sim 40V, T_a=25^{\circ}C$	140	190	240	$\mu A$
Frequency	$f_{OSC}$	$V_{PIN5}=0, C_T=1nF, T_a=25^{\circ}C$	28	33	40	KHz
Discharge to Charge Current Ratio	$I_{dischg}/I_{chg}$	$V_{PIN7}=V_{CC}, T_a=25^{\circ}C$	5.2	6	7.5	
Current Limit Sense Voltage	$V_{IPK}$	$I_{dischg}=I_{chg}, T_a=25^{\circ}C$	250	300	350	mV
<i>Output Switch</i>						
Saturation Voltage, Darlington Connection	$V_{CE(sat)1}$	$I_{SW}=1A, V_{C(SW)}=V_{C(DR)}$	-	1	1.3	V
Saturation Voltage	$V_{CE(sat)2}$	$I_{SW}=1A, I_{C(DR)}=50mA$	-	0.4	0.7	V
DC Current Gain	$h_{FE}$	$I_{SW}=1A, V_{CE}=5V$	35	120	-	
Collector Off-State Current	$I_{CC(off)}$	$V_{CE}=40V, T_a=25^{\circ}C$	-	10	100	$\mu A$
<i>Comparator</i>						
Threshold Voltage	$V_{FB}$		1.23	1.25	1.27	V
Threshold Voltage Line Regulation	$\Delta V_{FB}$	$V_{CC}=5\sim 40V$	-	1.5	6	mV
Input Bias Current	$I_{IB}$	$V_{IN}=0V$	-	40	400	nA
<i>Total Device</i>						
Supply Current	$I_{CC}$	$V_{CC}=5\sim 40V, V_{PIN7}=V_{CC}, V_{PIN5}>V_{FB}, C_T=0.001\mu F, Pin7=GND, Remaining pins open$	-	1.6	3	mA

## Block Diagram



## Application Information

Design Formula Table

Calculation	Step-Down	Step-Up	Voltage-Inverting
$t_{on}/t_{off}$	$(V_{out}+V_F)/(V_{in(min)}-V_{sat}-V_{out})$	$(V_{out}+V_F-V_{in(min)})/(V_{in(min)}-V_{sat})$	$( V_{out} +V_F)/(V_{in(max)}-V_{sat})$
$(t_{on}+t_{off})_{max}$	$1/F_{min}$	$1/F_{min}$	$1/F_{min}$
$C_T$	$4*10^{-5}t_{on}$	$4*10^{-5}t_{on}$	$4*10^{-5}t_{on}$
$I_{C(sw)}$	$2*I_{out(max)}$	$2*I_{out(max)}(t_{on}+t_{off}/t_{off})$	$2*I_{out(max)}(t_{on}+t_{off}/t_{off})$
$R_S$	$0.3/I_{C(sw)}$	$0.3/I_{C(sw)}$	$0.3/I_{C(sw)}$
$L_{(min)}$	$(V_{in(min)}-V_{sat}/I_{pk(sw)})^*t_{on(max)}$	$(V_{in(min)}-V_{sat}/I_{pk(sw)})^*t_{on(max)}$	$(V_{in(min)}-V_{sat}/I_{pk(sw)})^*t_{on(max)}$
$C_O$	$(I_{pk(sw)}*(t_{on}+t_{off}))/(8*V_{ripple(P-P)})$	$I_{out}^*t_{on}/V_{ripple(P-P)}$	$I_{out}^*t_{on}/V_{ripple(P-P)}$

$V_{sat}$ : Saturation voltage of the output switch.

$V_F$ : Forward voltage drop of the ringback rectifier.

The following power supply characteristics must be chosen:

$V_{in}$ : Nominal input voltage.

$V_{out}$ : Desired output voltage.  $|V_{out}|=1.25*(1+R_B/R_A)$

$I_{out}$ : Desired output current

$F_{min}$ : Minimum desired output switching frequency at the selected values for  $V_{in}$  and  $I_{out}$ .

$V_{ripple(P-P)}$ : Desired peak to peak output ripple voltage in practice, the calculated value will need to be increased due to the capacitor equivalent series resistance and board layout. The ripple voltage should be kept to a low value since it will directly effect the line and load regulation.

## Application Information (Continuos)

Fig.2 Step-Up Converter

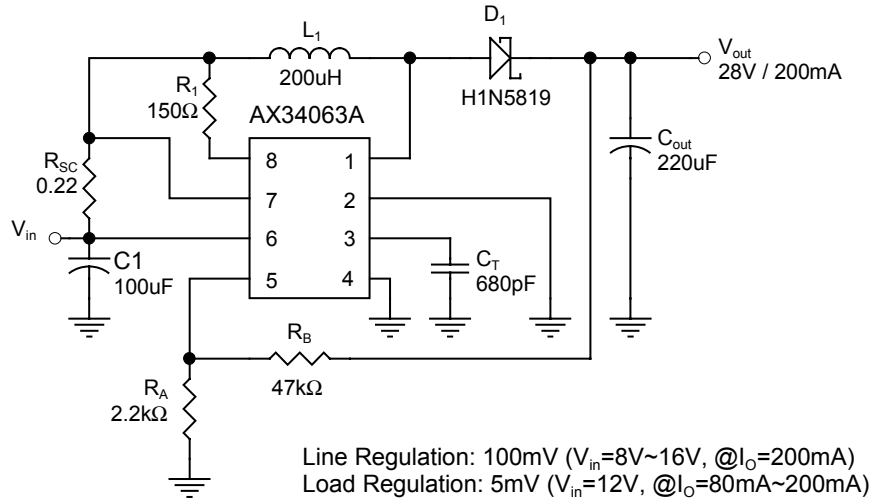


Fig.3 Step-Up Converter With External NPN Switch

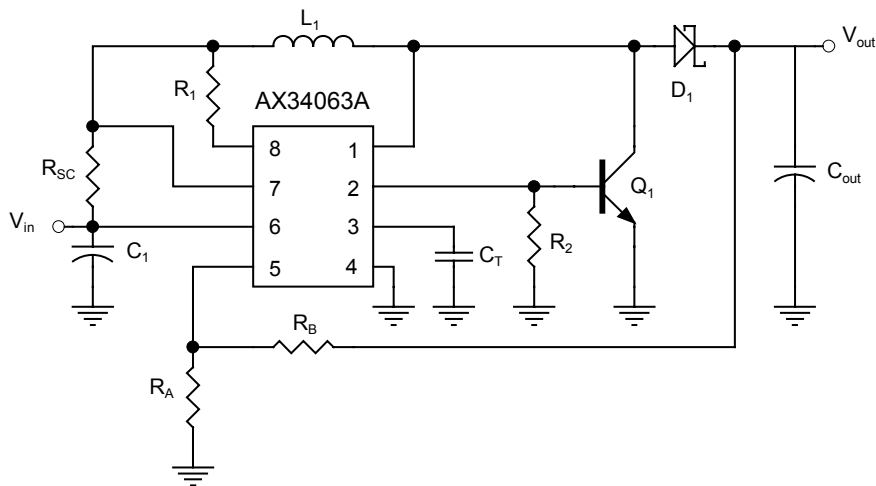


Fig.4 Step-Down Converter

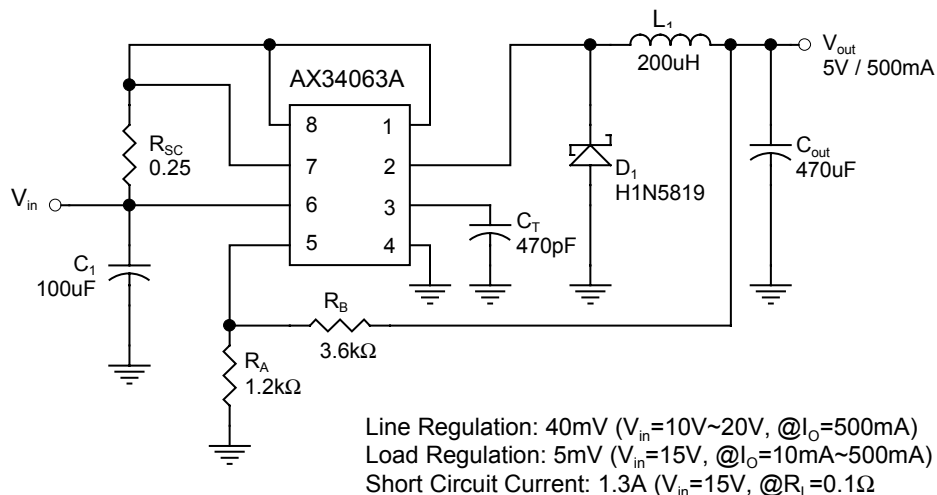


Fig.5 Step-Down Converter With External PNP Saturation Switch

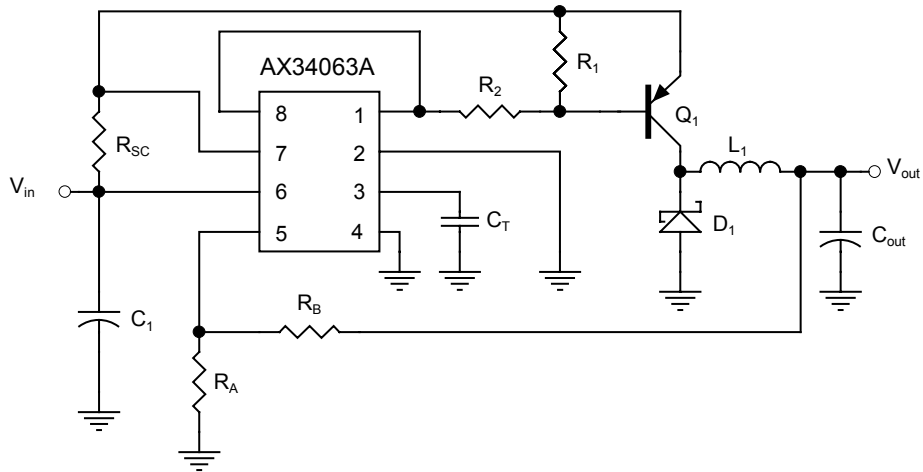


Fig.6 Voltage Inverting Converter

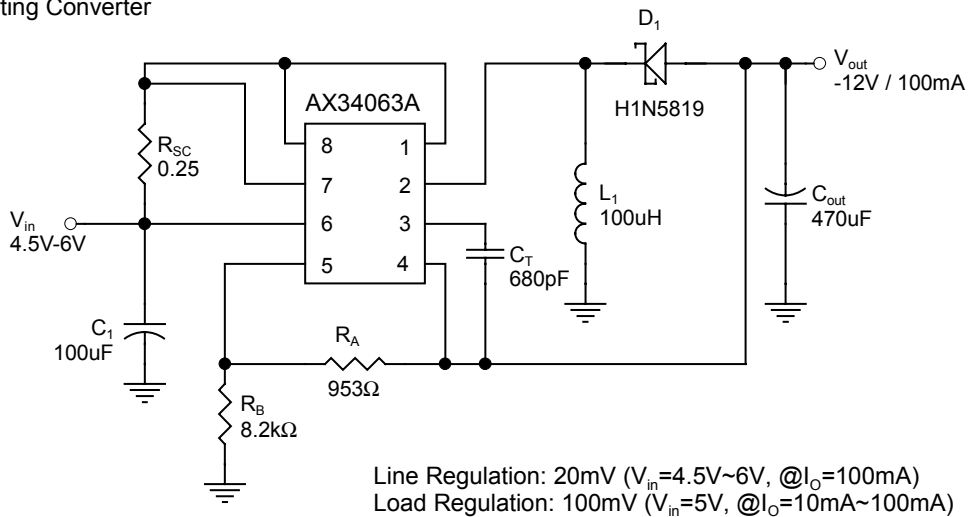
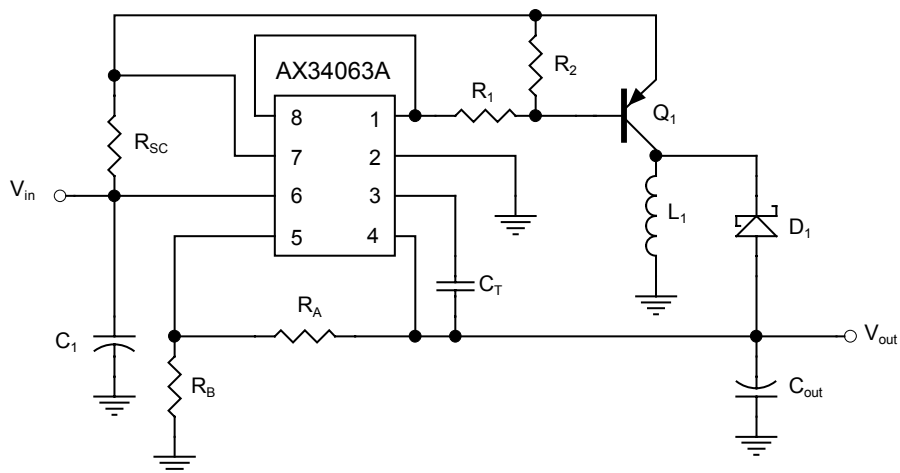
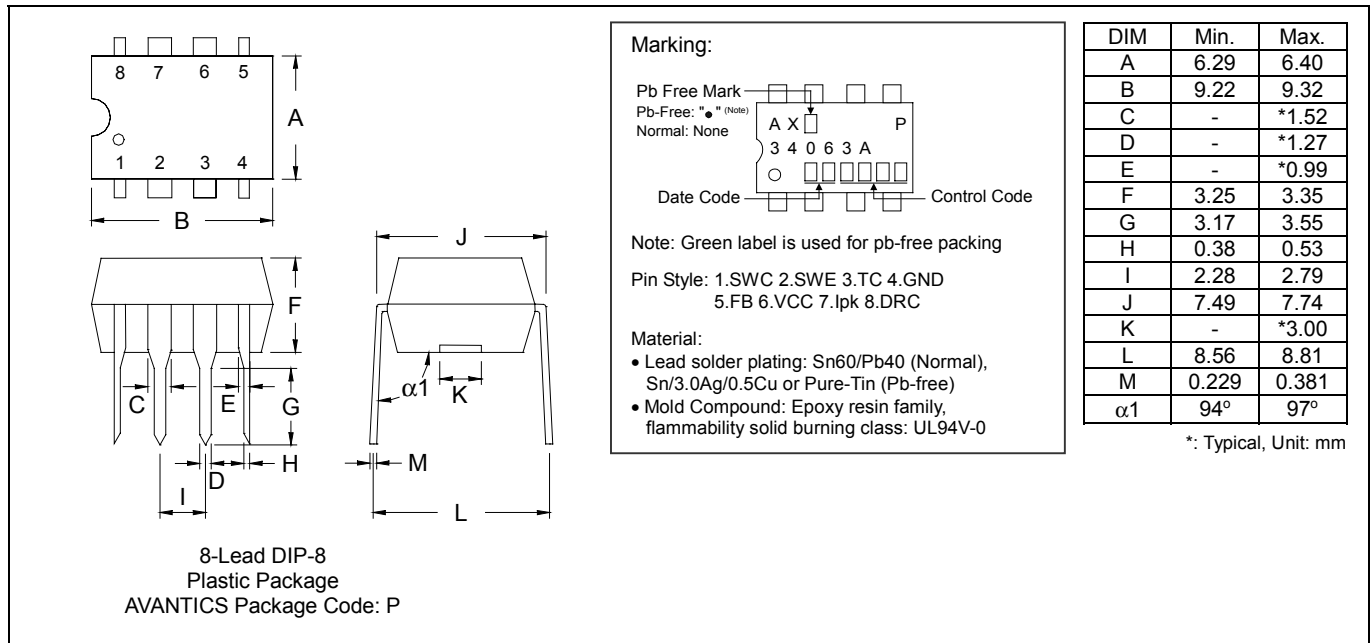


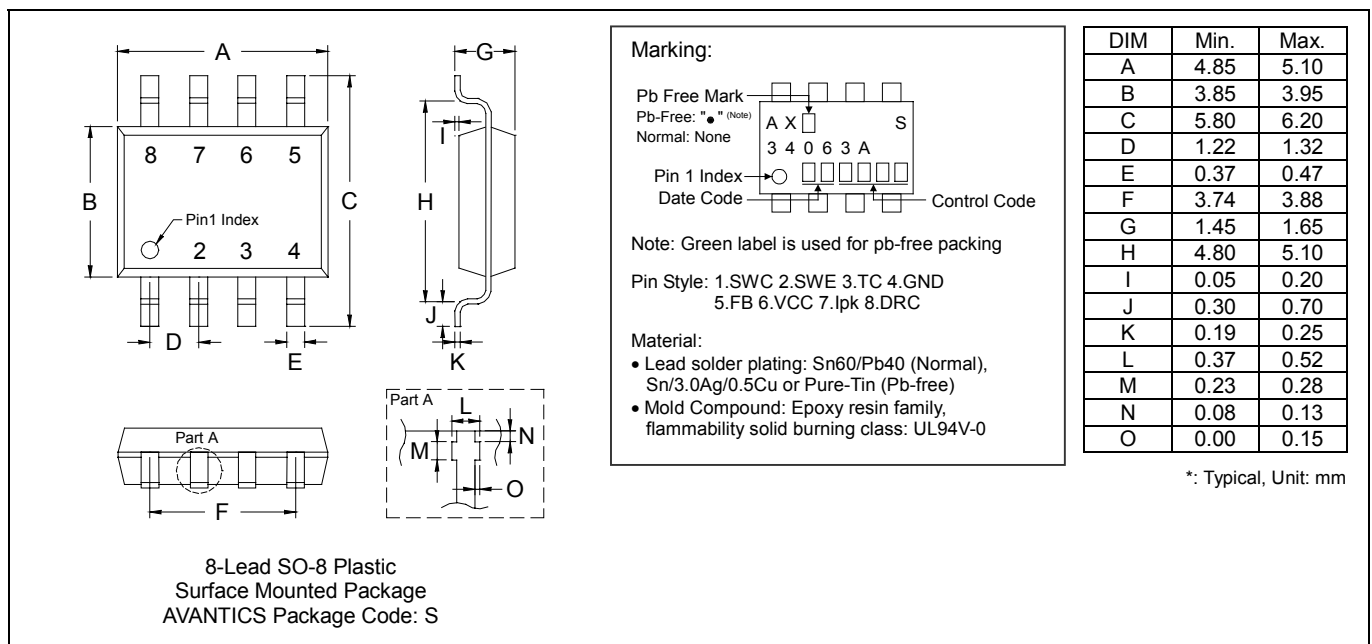
Fig.7 Voltage Inverting Converter With External PNP Saturation Switch



## DIP-8 Dimension



## SO-8 Dimension



### Important Notice:

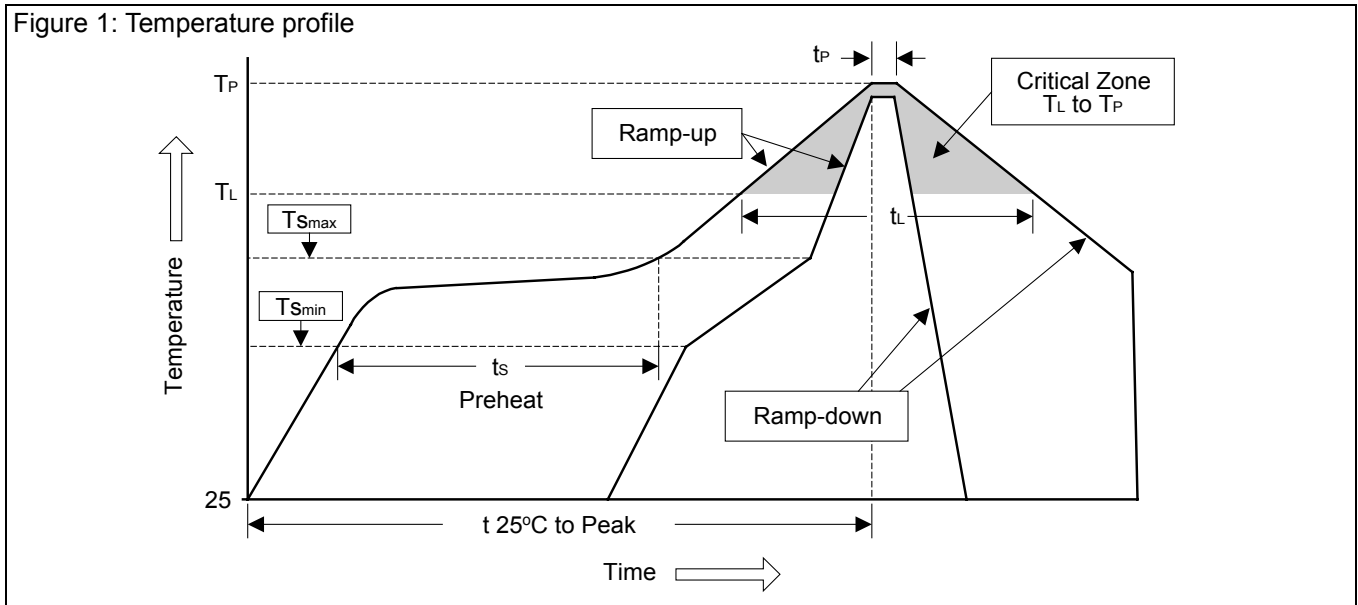
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### Head Office:

- AVANTICS Microelectronics Corp: No. 255, Cai Lun Rd. Zhangjiang Technology Industrial Park Pudong, Shanghai, China  
Tel: 86-021-58955599 Fax: 86-021-58558038

## Soldering Methods for AVANTICS's Products

1. Storage environment: Temperature=10°C~35°C Humidity=65%±15%
2. Reflow soldering of surface-mount devices



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate ( $T_L$ to $T_P$ )	<3°C/sec	<3°C/sec
Preheat		
- Temperature Min ( $T_{smin}$ )	100°C	150°C
- Temperature Max ( $T_{smax}$ )	150°C	200°C
- Time (min to max) ( $t_s$ )	60~120 sec	60~180 sec
$T_{smax}$ to $T_L$		
- Ramp-up Rate	<3°C/sec	<3°C/sec
Time maintained above:		
- Temperature ( $T_L$ )	183°C	217°C
- Time ( $t_L$ )	60~150 sec	60~150 sec
Peak Temperature ( $T_P$ )	240°C +0/-5°C	260°C +0/-5°C
Time within 5°C of actual Peak Temperature ( $t_P$ )	10~30 sec	20~40 sec
Ramp-down Rate	<6°C/sec	<6°C/sec
Time 25°C to Peak Temperature	<6 minutes	<8 minutes

### 3. Flow (wave) soldering (solder dipping)

Products	Peak temperature	Dipping time
Pb devices.	245°C ±5°C	5sec ±1sec
Pb-Free devices.	260°C +0/-5°C	5sec ±1sec